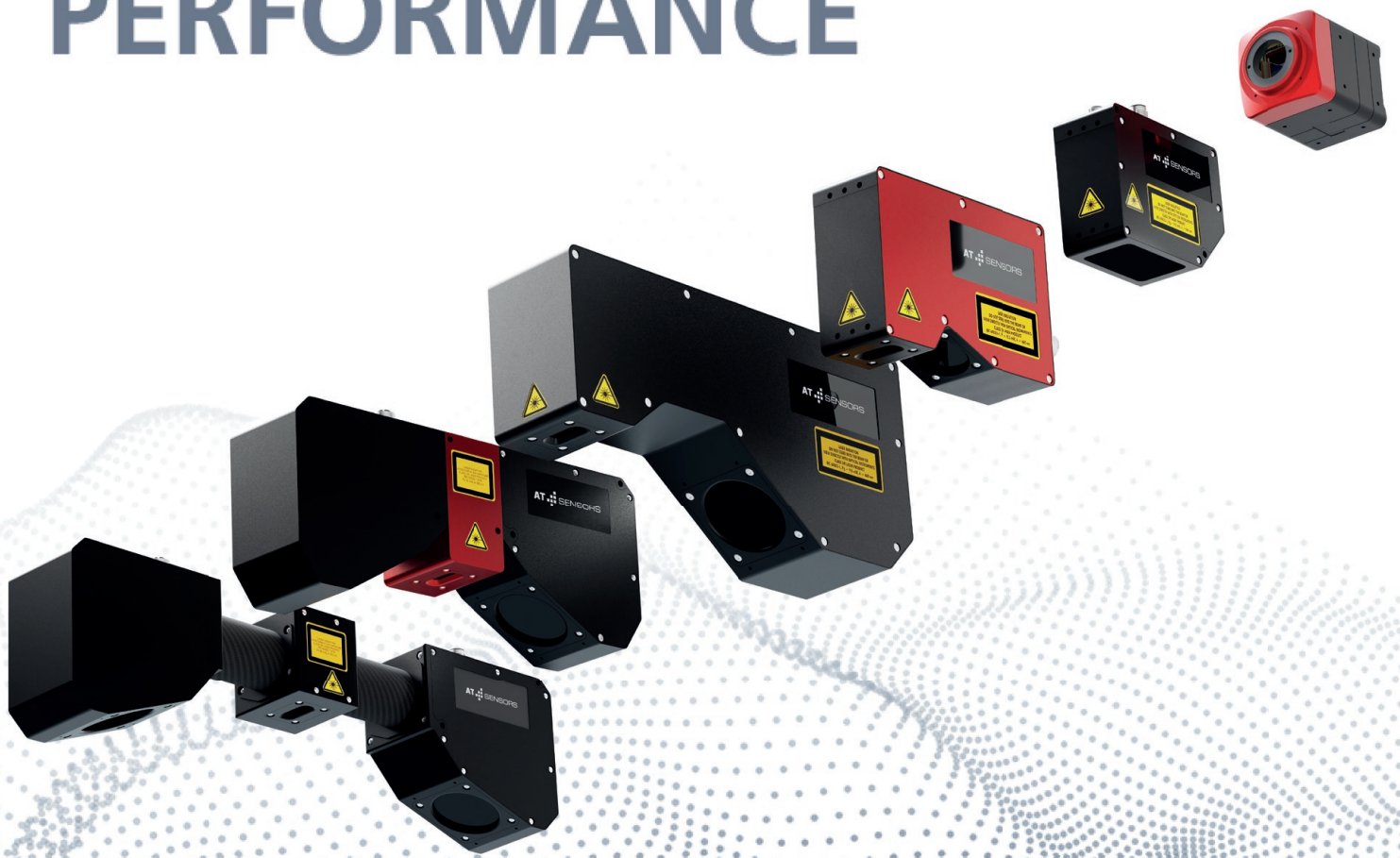


CUSTOMIZATION
BUDGET **FLEXIBILITY**
PERFORMANCE



3D Laser Profile Sensors

TAILORED

3D Laser Profiler Sensors

SOLUTIONS

3D Vision Portfolio

The C6 and C7 series of laser profile sensors from AT is based on a new sensor platform that supports the latest industry standard GigE Vision/GenICam 3D with up to 5 Gbit/s. The laser profilers offer an impressive combination of extremely high-speed and high-precision resolution, enabling the profilers to enter worlds that 3D imaging has not seen before. They feature profile resolution up to 4096 points per profile and profile speed up to 140 kHz as well as high dynamic range 3D image acquisition. Available as compact sensor, MCS and 3D camera.



Compact Sensors (CS)

- ✓ Factory calibrated laser profile sensors
- ✓ Wide range of models with X-FOV 7 - 1290 mm
- ✓ Four different sensor resolutions available (1280, 2040, 3070, 4090)
- ✓ High industrial protection class IP67
- ✓ Available with various laser configurations
- ✓ Resolution Z up to 0.2 μm



Modular Compact Sensors (MCS)

- ✓ Factory assembled and calibrated 3D laser triangulation sensors consisting of sensor module, laser module and link module
- ✓ Customized Laser Profile Sensor designs without NRE or MOQ
- ✓ Four different sensor resolutions available (1280, 2040, 3070, 4090)
- ✓ Configurable according to application requirements like X-FOV, working distance, triangulation angle, number of points per profile, laser wavelength and laser safety class
- ✓ Dual-Head configuration possible for occlusion-free 3D scans
- ✓ High industrial protection class IP67



3D Cameras

- ✓ Designed for flexible laser triangulation setups with user-defined lasers and lenses
- ✓ Four different sensor resolutions available (1280, 2040, 3070, 4090)
- ✓ High industrial protection class IP67
- ✓ Available with various lens mounts and Scheimpflug adapters
- ✓ Lens protection tubes

KEY FACTS

By Professionals for Professionals

Highest Resolution

- ✓ Profile resolution up to 4096 points/profile
- ✓ Sophisticated 3D laser line detection algorithms for every application (FIR-PEAK, MAX, COG, TRSH)
- ✓ Resolution X: up to 5 μm
- ✓ Resolution Z: up to 0.2 μm

Unique Features

- ✓ GenICam 3.0: support of latest 3D standards
- ✓ MultiPart: parallel output of different features (e.g. range, reflectance, scatter) at maximum profile speed with optimized pixel formats
- ✓ MultiPeak: output of up to four different peaks for even more robust 3D data and for scanning transparent or shiny objects
- ✓ Region search and tracking: automatically finds and tracks the laser line in the detector image



Unmatched Profile Speed

- ✓ Profile speed up to 140 kHz
- ✓ 3D data rate up to 128 million 3D points per second
- ✓ Increase profile speed by defining detector regions
- ✓ Support up to four regions

Various Models

- ✓ Wide range of compact sensors with X-FOV 7 - 1290 mm and numerous laser configurations
- ✓ Wide range of detectors with different resolutions (1280 - 4096 pixel/profile)

Modular Concept

- ✓ Modular Compact Sensors (MCS): individual design optimized for your requirements
- ✓ No additional development costs
- ✓ No minimum order quantity
- ✓ Short delivery time

3070 SENSOR CHIP

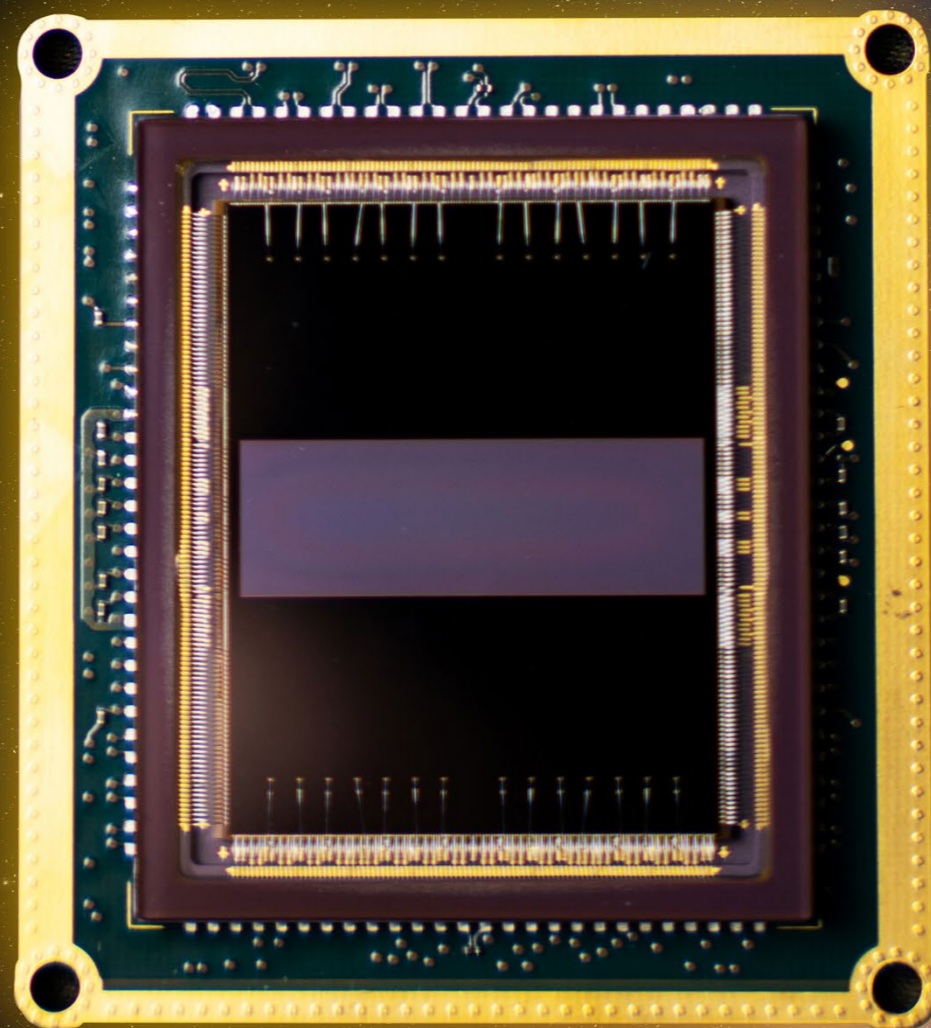
World's Fastest 3D Image Sensor

WARP Speed

- ✓ Widely Advanced Rapid Profiling (WARP)
- ✓ Unmatched profile speed
- ✓ Three different speed levels

On-Chip Processing

- ✓ Internal processing speed of 29 gigapixels/s
- ✓ 3D profile pixel output rate of 128 megapixels/s



AT's Sensor Technology

- ✓ Exclusive 3K imager design developed by AT
- ✓ High sensitivity and high dynamic range pixel design
- ✓ Integrated on-chip processing

World's Fastest Profiling

- ✓ Worldwide fastest 3D image sensor in the combination of speed and resolution
- ✓ Intelligent line detection algorithms with advanced filtering and validation for highly accurate scans

Ten Times Faster 3D Scans

AT LASER PROFILERS

Overview



- ✓ Large selection of field of views
- ✓ Five different sensor models available

Typical Industries: Automotive, Logistics & Packaging, Wood & Lumber, Pharma, Robotics & Automation, Iron & Steel



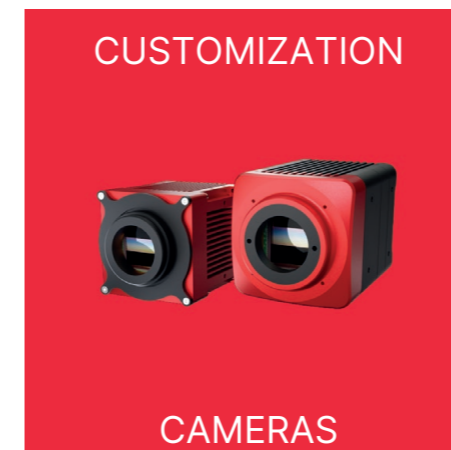
- ✓ Optimal price-performance ratio
- ✓ Cost-efficient

Typical Industries: Food & Beverage, Logistics & Packaging, Robot Vision



- ✓ Extremely high resolution
- ✓ High-quality laser line projection
- ✓ No occlusion with dual-head option

Typical Industries: Electronics, Semicon



- ✓ Compatible with custom components
- ✓ Optimal for complex multi-sensor applications
- ✓ Available with different Scheimpflug configurations

Typical Industries: Iron & Steel, Plastics, Electronics, Transportation, Robotics & Automation



- ✓ Modular sensor concept for individual solutions
- ✓ No extra costs, short delivery time and no minimum order quantities

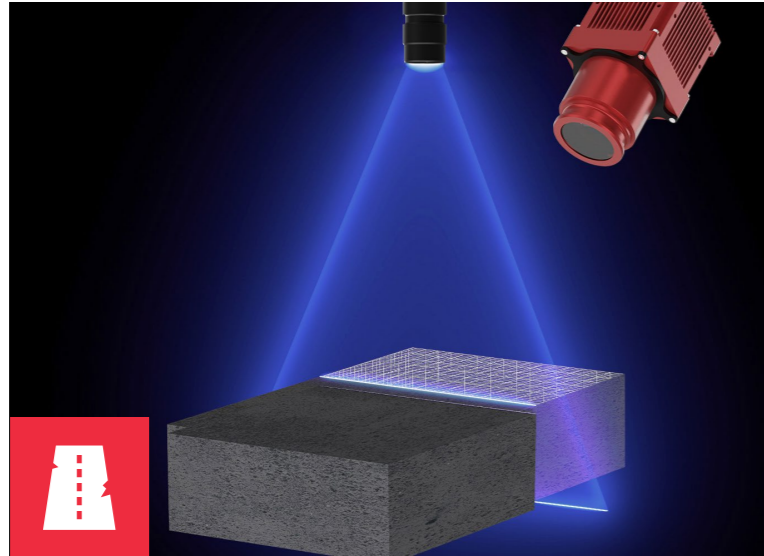
Typical Industries: Automotive, Logistics & Packaging, Wood & Lumber, Pharma, Robotics & Automation, Iron & Steel, Plastics, Transportation, Metrology, Sorting & Recycling



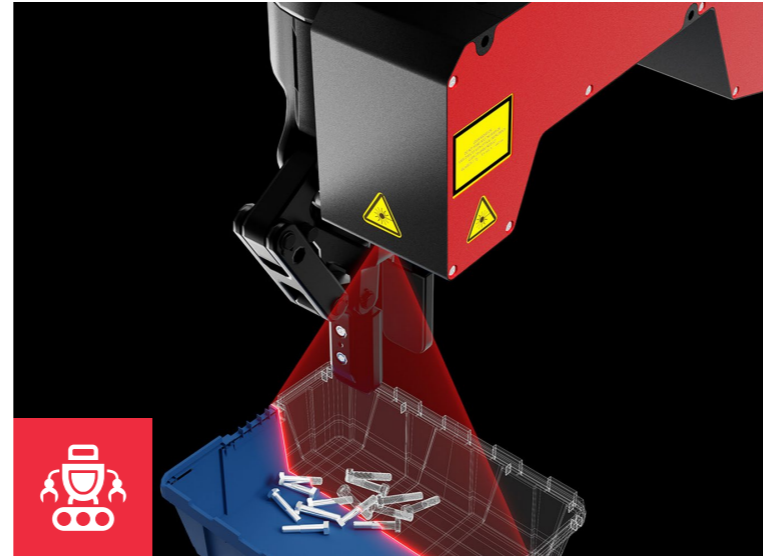
- ✓ Ideal for integration in OEM devices
- ✓ Different sensor and laser modules available

Typical Industries: OEM specific

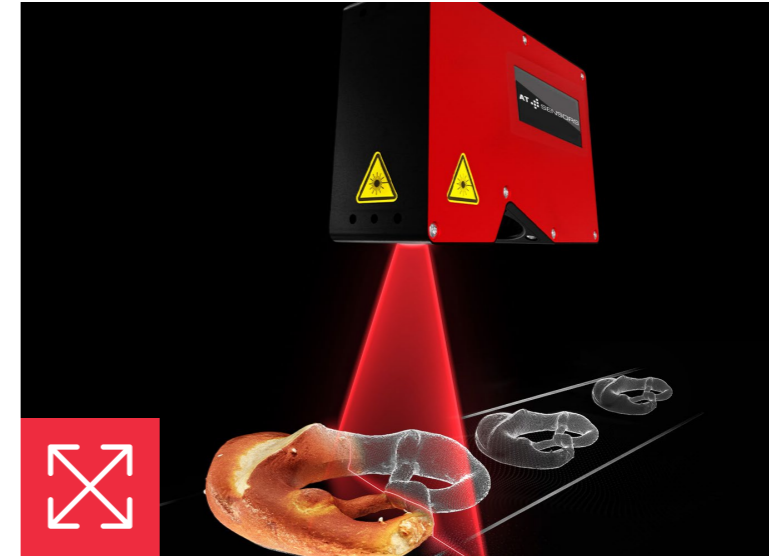
APPLICATION VARIETY



Brick Inspection



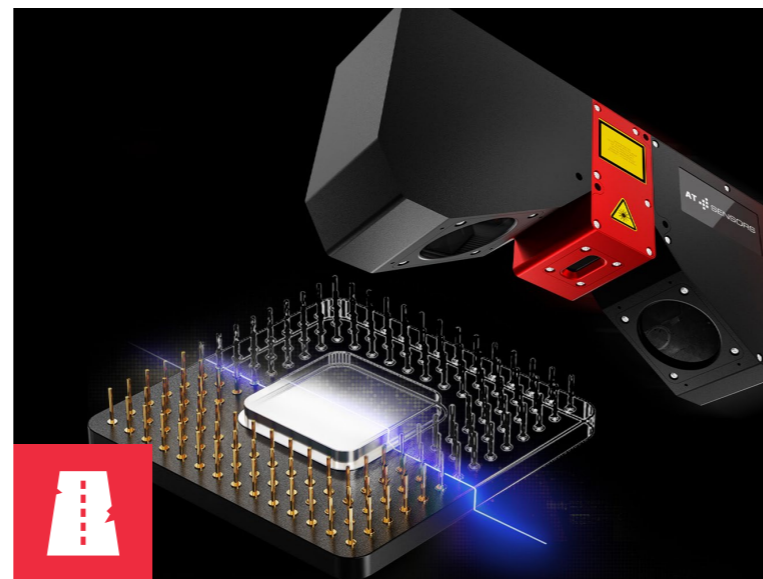
Position Recognition



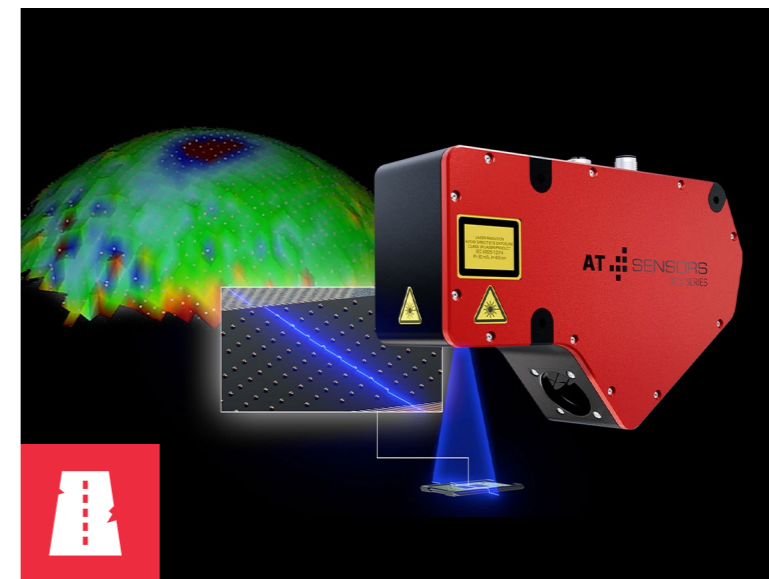
Baking Volume Control



Steel Slab Inspection



Pin Inspection



BGA Inspection



Surface
Inspection



Robot
Guidance



Metrology

COMPACT SENSORS

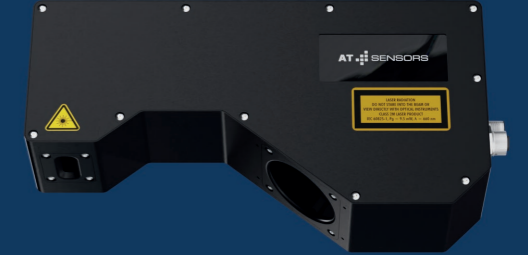


3D Compact Sensor Housing Model G6

- ✓ Profile resolution up to 2048 points / profile
- ✓ Profile speed up to 140 kHz
- ✓ Wide range of models with X-FOV 7 - 53 mm
- ✓ Nominal working distance: 31 - 90 mm
- ✓ Resolution X: 5 - 26 μm
- ✓ Resolution Z: 0.2 - 1.2 μm
- ✓ Z-Range 5 - 46 mm
- ✓ Linearity Z: +/-0.01 % of Z-Range
- ✓ Repeatability Z: 0.1 - 0.5 μm

3D Compact Sensor Housing Model G5

- ✓ Profile resolution up to 4096 points / profile
- ✓ Profile speed up to 25 kHz
- ✓ Wide range of models with X-FOV 82 and 145 mm
- ✓ Nominal working distance: 172 mm
- ✓ Resolution X: 20 - 35 μm
- ✓ Resolution Z: 0.5 - 0.9 μm
- ✓ Z-Range 15 mm
- ✓ Linearity Z: +/-0.01 % of Z-Range
- ✓ Repeatability Z: 0.4 - 0.7 μm



3D Compact Sensor Housing Model G1

- ✓ Profile resolution up to 2048 points / profile
- ✓ Profile speed up to 140 kHz
- ✓ Wide range of models with X-FOV 29 - 160 mm
- ✓ Nominal working distance: 106 - 197 mm
- ✓ Resolution X: 19 - 78 μm
- ✓ Resolution Z: 0.8 - 5.9 μm
- ✓ Z-Range 40 - 80 mm
- ✓ Linearity Z: +/-0.01 % of Z-Range
- ✓ Repeatability Z: 0.4 - 6.6 μm

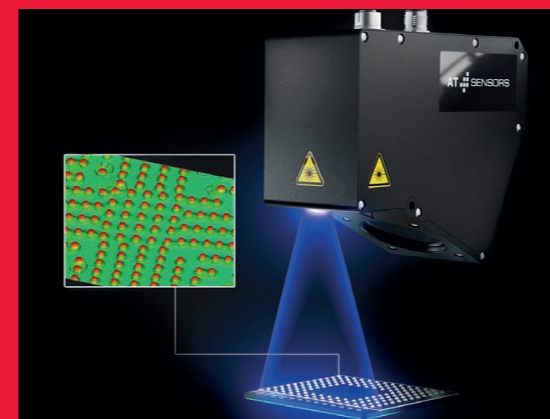
3D Compact Sensor Housing Model G3

- ✓ Profile resolution up to 4096 points / profile
- ✓ Profile speed up to 140 kHz
- ✓ Wide range of models with X-FOV 182 - 1290 mm
- ✓ Nominal working distance: 400 - 944 mm
- ✓ Resolution X: 44 - 586 μm
- ✓ Resolution Z: 1.4 - 35.3 μm
- ✓ Z-Range 250 - 1090 mm
- ✓ Linearity Z: +/-0.01 % of Z-Range
- ✓ Repeatability Z: 2.1 - 10.0 μm



Good to know:

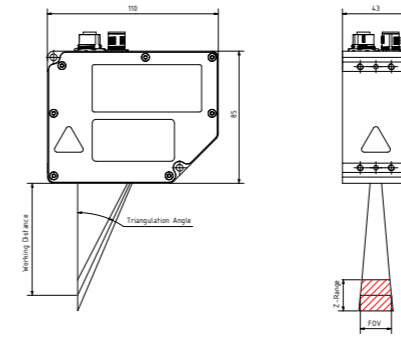
- ✓ Factory calibrated laser profile sensors
- ✓ Wide range of models with X-FOV 7 - 1290 mm
- ✓ Four different sensor resolutions available (1280, 2040, 3070, 4090)
- ✓ High industrial protection class IP67
- ✓ Available with various laser configurations
- ✓ Resolution Z up to 0.2 μm



Recommended Applications:

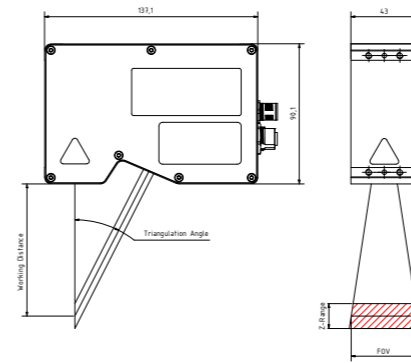
- ✓ Electronics & Semicon
- ✓ eMobility & Battery
- ✓ Automotive
- ✓ Metrology
- ✓ Industrial Automation
- ✓ Transportation
- ✓ Iron & Steel
- ✓ Pharmaceuticals
- ✓ Sorting & Recycling

Housing Model G6									
Model Name	Nominal X-FOV	Z-Range	Nominal Working Distance	Resolution X (μm)	Resolution Z (μm)	Points per Profile	Profile Speed (kHz)	Laser Wavelength (nm)	Laser Safety Class
C6-1280CS35-7	7 mm (0.27 in)	5.2 mm (0.20 in)	31 mm (1.22 in)	5	0.2	1280	140	405, 450	2M, 3R, 3B
C6-1280CS35-12	12 mm (0.47 in)	8 mm (0.31 in)	31 mm (1.22 in)	10	0.2	1280	140	405, 450	2M, 3R, 3B
C6-1280CS25-20	20 mm (0.78 in)	20 mm (0.78 in)	72 mm (2.83 in)	16	0.5	1280	140	405, 450	2M, 3R, 3B
C6-1280CS21-40	40 mm (1.57 in)	46 mm (1.81 in)	90 mm (3.54 in)	31	1.2	1280	140	405	2M, 3R, 3B
C6-2040CS21-53	53 mm (2.08 in)	46mm (1.81 in)	90 mm (3.54 in)	26	1	2048	25	405	2M, 3R, 3B



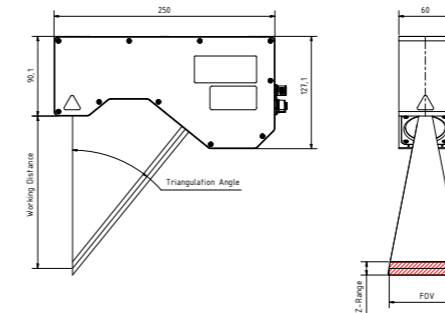
Housing Model G6

Housing Model G1									
Model Name	Nominal X-FOV	Z-Range	Nominal Working Distance	Resolution X (μm)	Resolution Z (μm)	Points per Profile	Profile Speed (kHz)	Laser Wavelength (nm)	Laser Safety Class
C6-1280CS23-29	29 mm (1.14 in)	40 mm (1.57 in)	106 mm (4.17 in)	23	0.8	1280	140	405, 660	2M, 3R, 3B
C6-2040CS23-38	38 mm (1.49 in)	30 mm (1.18 in)	106 mm (4.17 in)	19	0.7	2048	25	405, 660	2M, 3R, 3B
C6-1280CS23-47	47 mm (1.85 in)	40 mm (1.57 in)	106 mm (4.17 in)	37	1.4	1280	140	405, 660	2M, 3R, 3B
C6-2040CS23-63	63 mm (2.48 in)	40 mm (1.57 in)	106 mm (4.17 in)	31	1.2	2048	25	405, 660	2M, 3R, 3B
C6-1280CS23-75	75 mm (2.95 in)	40 mm (1.57 in)	106 mm (4.17 in)	59	2.3	1280	140	405, 660	2M, 3R, 3B
C6-1280CS14-76	76 mm (2.99 in)	80 mm (3.14 in)	197 mm (7.75 in)	59	3.5	1280	140	405, 660	2M, 3R, 3B
C6-2040CS14-100	100 mm (3.93 in)	120 mm (4.72 in)	197 mm (7.75 in)	49	2.9	2048	25	405, 660	2M, 3R, 3B
C6-2040CS23-100	100 mm (3.93 in)	60 mm (2.36 in)	106 mm (4.17 in)	49	1.9	2048	25	405, 660	2M, 3R, 3B
C6-1280CS14-120	120 mm (4.72 in)	120 mm (4.72 in)	197 mm (7.75 in)	94	5.9	1280	140	405, 660	2M, 3R, 3B
C6-2040CS14-160	160 mm (6.29 in)	80 mm (3.14 in)	197 mm (7.75 in)	78	4.9	2048	25	405, 660	2M, 3R, 3B



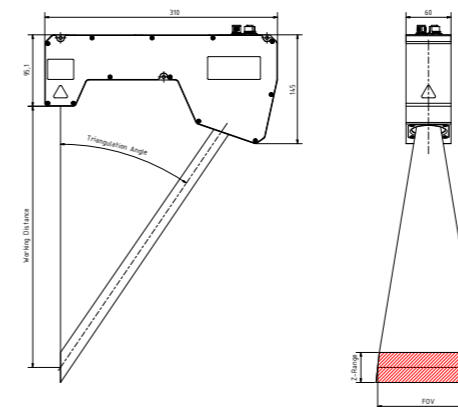
Housing Model G1

Housing Model G5									
Model Name	Nominal X-FOV	Z-Range	Nominal Working Distance	Resolution X (μm)	Resolution Z (μm)	Points per Profile	Profile Speed (kHz)	Laser Wavelength (nm)	Laser Safety Class
C6-4090CS39-82	82 mm (3.22 in)	15 mm (0.59 in)	172 mm (6.77 in)	20	0.5	4096	20	405, 660	2M, 3R, 3B
C6-4090CS39-145	145 mm (5.70 in)	15 mm (0.59 in)	172 mm (6.77 in)	35	0.9	4096	20	405, 660	2M, 3R, 3B



Housing Model G5

Housing Model G3									
Model Name	Nominal X-FOV	Z-Range	Nominal Working Distance	Resolution X (μm)	Resolution Z (μm)	Points per Profile	Profile Speed (kHz)	Laser Wavelength (nm)	Laser Safety Class
C6-4090CS30-182	182 mm (7.16 in)	150 mm (6.25 in)	400 mm (15.74 in)	44	1.4	4096	25	405, 660	2M, 3R, 3B
C6-1280CS30-248	248 mm (9.76 in)	200 mm (7.87 in)	400 mm (15.74 in)	194	6.1	1280	140	405, 660	2M, 3R, 3B
C6-4090CS30-288	288 mm (11.33 in)	250 mm (9.84 in)	400 mm (15.74 in)	70	2.2	4096	25	405, 660	2M, 3R, 3B
C6-2040CS30-330	330 mm (12.99 in)	200 mm (7.87 in)	400 mm (15.74 in)	161	5.0	2048	25	405, 660	2M, 3R, 3B
C6-2040CS18-1060	1060 mm (41.73 in)	800 mm (31.49 in)	744 mm (29.29 in)	518	26.2	2048	25	405, 660	2M, 3R, 3B
C6-2040CS15-1290	1290 mm (50.78 in)	1090 mm (42.91 in)	920 mm (36.22 in)	630	38.0	2048	25	405, 660	2M, 3R, 3B



Housing Model G3

MODULAR COMPACT SENSOR



Configurable according to application requirements:

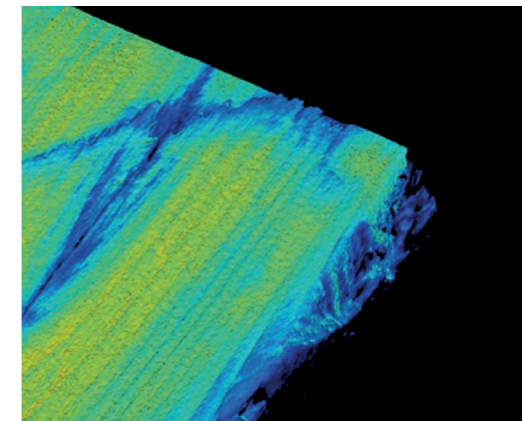
- ✓ X-FOV
- ✓ Working distance
- ✓ Triangulation angle
- ✓ Number of points per profile
- ✓ Laser wavelength
- ✓ Laser safety class

Sensor Specification

X-FOV at Working Distance	> 2000 mm
Lateral X Resolution	down to 50 μm
Nominal Working Distance	> 1700 mm
Nominal Triangulation Angle	15°, 20°, 25°, 30°, 40°
Profile Resolution	1280, 2040, 3072, 4096 points per profile
Profile Speed	up to 140 kHz
Available Sensor Modules	1280, 2040, 3070, 3070W (WARP), 4090

Laser Specification

Laser Wavelength	405, 660 nm
Laser Power	up to 200 mW
Laser Class	2M, 3R, 3B



Good to know:

- ✓ Factory assembled and calibrated 3D laser profile sensors consisting of sensor module, laser module and link module
- ✓ Customized laser profile sensor designs without NRE or MOQ
- ✓ Four different sensor resolutions available (1280, 2040, 3070, 4090)
- ✓ Configurable according to application requirements like X-FOV, working distance, triangulation angle, number of points per profile, laser wavelength and laser safety class
- ✓ Dual-head configuration possible for occlusion-free 3D scans
- ✓ High industrial protection class IP67



Recommended Applications:

- ✓ Electronics & Semicon
- ✓ eMobility & Battery
- ✓ Automotive
- ✓ Metrology
- ✓ Industrial Automation
- ✓ Transportation
- ✓ Iron & Steel
- ✓ Pharmaceuticals
- ✓ Sorting & Recycling

MCS

with High-Power Laser

Different Configurations available



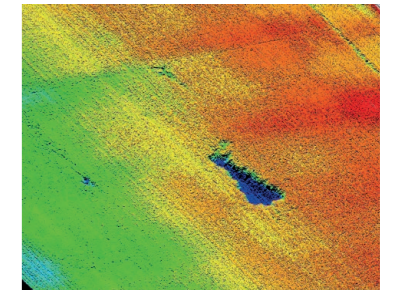
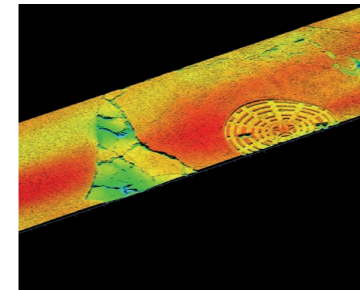
AT Sensors has expanded the range of its modular sensor series (MCS). This now includes a powerful high-performance laser module, which has been developed primarily for demanding applications in the iron & steel industry as well as for infrastructure inspection and road scanning.

Comparison Laser Modules

	MCS Standard	MCS High Power Laser
Laser Wavelength	405, 660 nm	450, 760, 808 nm
Laser Power	up to 200 mW	up to 2500 mW
Laser Class	2M, 3R, 3B	3B

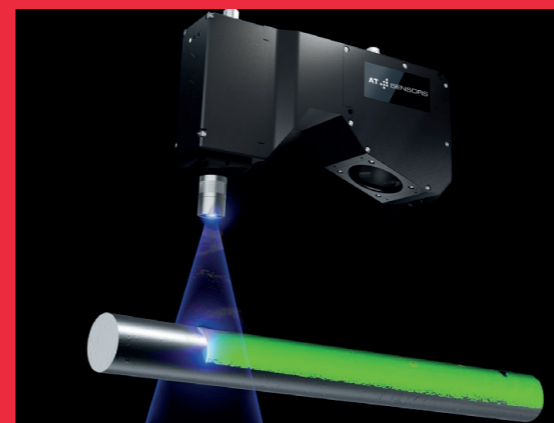
Benefits:

- Higher laser power (10x more output power compared to standard)
- Faster scan rates in demanding environmental conditions like difficult lighting such as bright ambient light
- For applications where high speed or a large working distance is required



Good to know:

- ✓ based on AT's unique modular 3D laser profile sensor concept
- ✓ World's fastest 3D profiling
- ✓ Intelligent data compression directly on the sensor chip
- ✓ Up to ten times faster 3D scans
- ✓ Profile speed up to 140 kHz
- ✓ High laser power through laser class 3R/3B
- ✓ Large field of view of up to 2800 mm



Recommended Applications:

- ✓ Road pavement scanning
- ✓ Inspection of cold or red-hot steel parts
- ✓ Scanning of railroad infrastructure

XCS SERIES

with 1 Gigabit/s

Available Models:

3070 WARP:

- ✓ 602344999 / C6-3070W-XCS-48-146-D-405-3R
- ✓ 602345000 / C6-3070W-XCS-48-146-S-405-3R

3070:

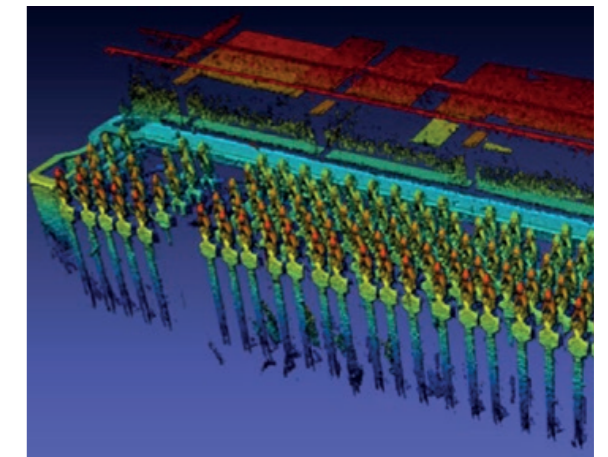
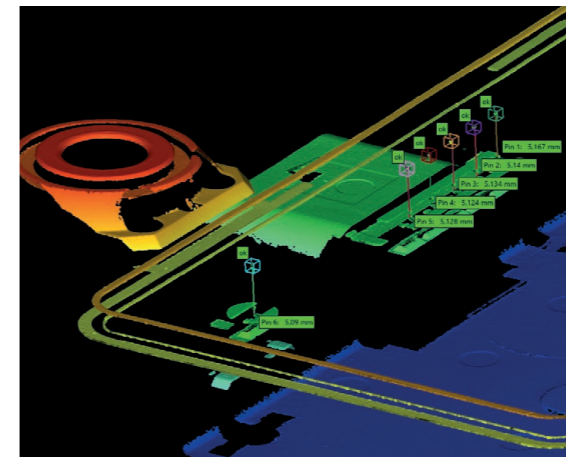
- ✓ 602345001 / C6-3070-XCS-48-146-D-405-3R
- ✓ 602345002 / C6-3070-XCS-48-146-S-405-3R

4090:

- ✓ 602344997 / C6-4090-XCS-53-146-D-405-3R
- ✓ 602344998 / C6-4090-XCS-53-146-S-405-3R

Benefits:

- Higher laser power (10x more output power compared to standard)
- Faster scan rates in demanding environmental conditions like difficult lighting such as bright ambient light
- For applications where high speed or a large working distance is required



Good to know:

- ✓ Unique 3D scan results without occlusion due to dual-head option and extremely high profile speed at 3072 or 4096 points per profile
- ✓ High precision and repeatability thanks to high-quality laser line projection
- ✓ Unrivaled optical resolution for electronic inspection (e.g. BGA inspection) with a field of view of up to 53 mm
- ✓ Highest inspection speed available with 3070 WARP sensor chip



Recommended Applications:

- ✓ Electronics & Semicon
- ✓ E-Mobility & Battery
- ✓ Automotive Metrology
- ✓ Industrial Automation
- ✓ Welding
- ✓ Pharmaceuticals
- ✓ Wood & Lumber

General Specifications for all XCS Models

Interface	Gigabit Ethernet (1GigE)
Inputs	Encoder A+, A -, B+, B -, Z+, Z- (TTL Level) Two freely configurable digital inputs (+5 to +24 VDC)
Outputs	Two freely configurable digital outputs (+5 to +24 VDC)
Power Supply	Sensor supply +10 to +24 VDC (max. +27 VDC) Laser supply +10 to +24 VDC
Housing	Anodized aluminum, IP67
Environmental Conditions	Operating temperature 0 °C to +40 °C Storage temperature -20 °C to +80 °C Humidity 20% to 80%
Vibration/Shock	Vibration resistance (sinusoidal): DIN EN 60068-2-6: 2008-10: 2g, 10-150 Hz Vibration resistance (random): DIN EN 60068-2-64: 2020-09: 7g, 10-500 Hz Shock resistance: DIN EN 60068-2-27: 2010-02: 15g, 3ms
Communication Protocols	GenICam, GigE Vision
Features	Automatic RegionTracking, Automatic RegionSearch, Multiple Regions, MultiPart, AutoStart, History Buffer, Multi-Slope, MultiPeak

Laser Specifications for all XCS Models

Laser Wavelength	405 nm
Laser Class	3R

Models 3070 / 3070 WARP

Part Number / Model Name	602344999 / C6-3070W-XCS-48-146-D-405-3R 602345000 / C6-3070W-XCS-48-146-S-405-3R 602345001 / C6-3070-XCS-48-146-D-405-3R 602345002 / C6-3070-XCS-48-146-S-405-3R
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Optical Setup 3070 / 3070 WARP

Lateral Resolution X	0.016 mm
Height Resolution Z	0.5 µm (with 6 subpixels)
Working Distance	146 mm
X-FOV	48 mm
Profile Resolution	3072 pixel per profile
Profile Speed	max. 140 kHz, 14.5 kHz @ full Z-Range
Z-Range Near to Far	20 mm

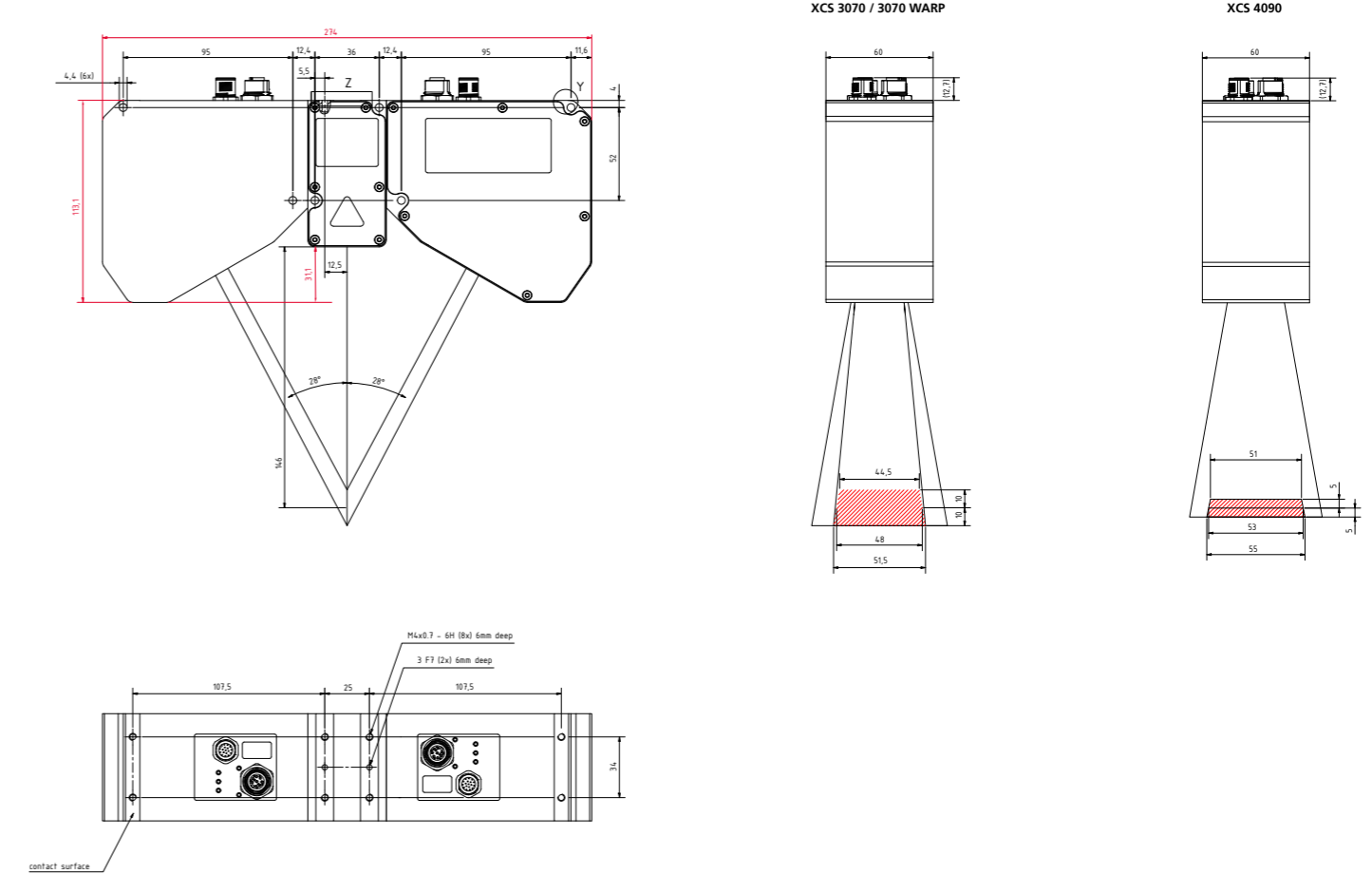
Models 4090

Part Number / Model Name	602344997 / C6-4090-XCS-53-146-D-405-3R 602344998 / C6-4090-XCS-53-146-S-405-3R
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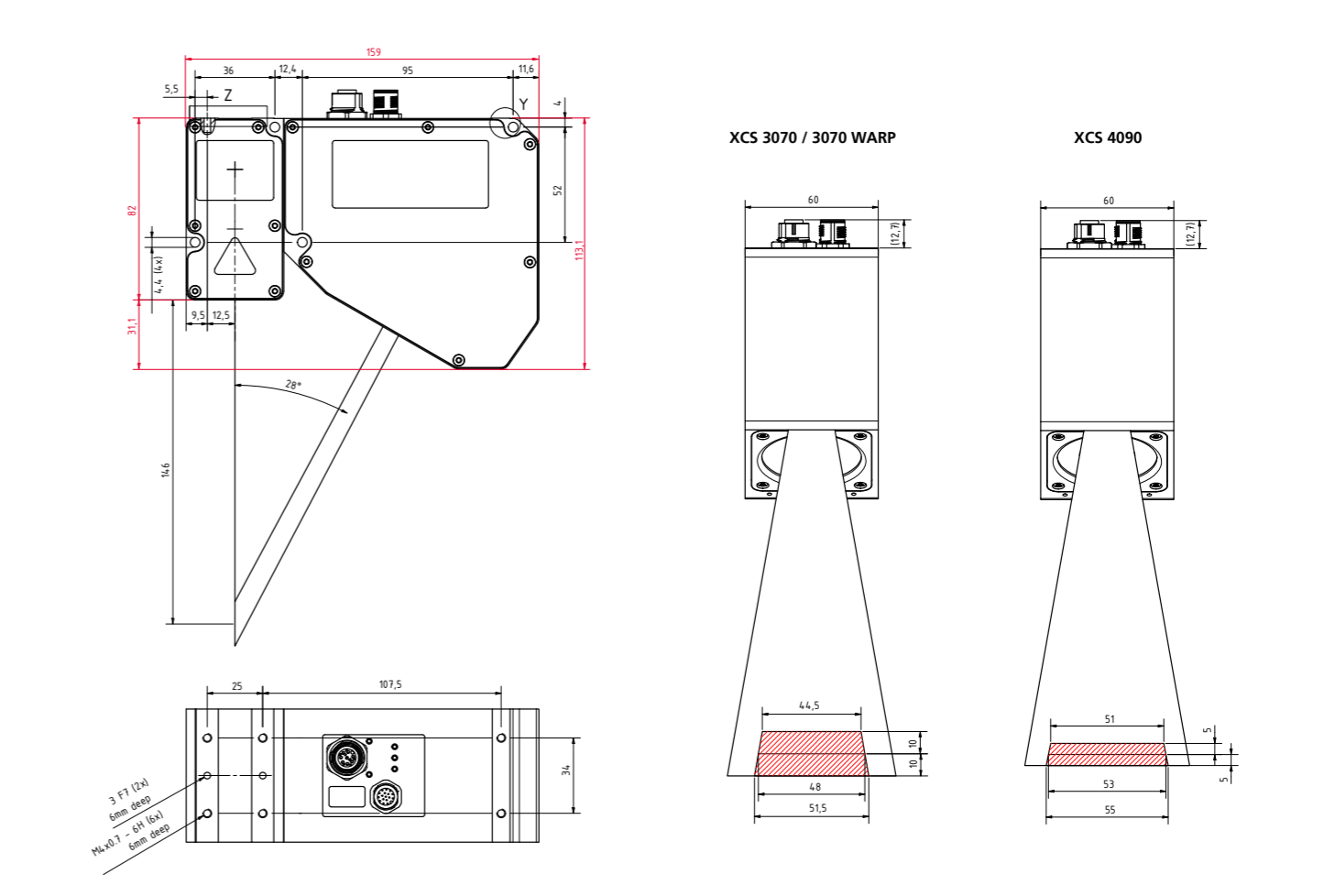
Optical Setup 4090

Lateral Resolution X	0.013 mm
Height Resolution Z	0.42 µm (with 6 subpixels)
Working Distance	146 mm
X-FOV	53 mm
Profile Resolution	4096 pixel per profile
Profile Speed	max. 20.3 kHz
Z-Range Near to Far	10 mm

Technical Drawings Dual-Head

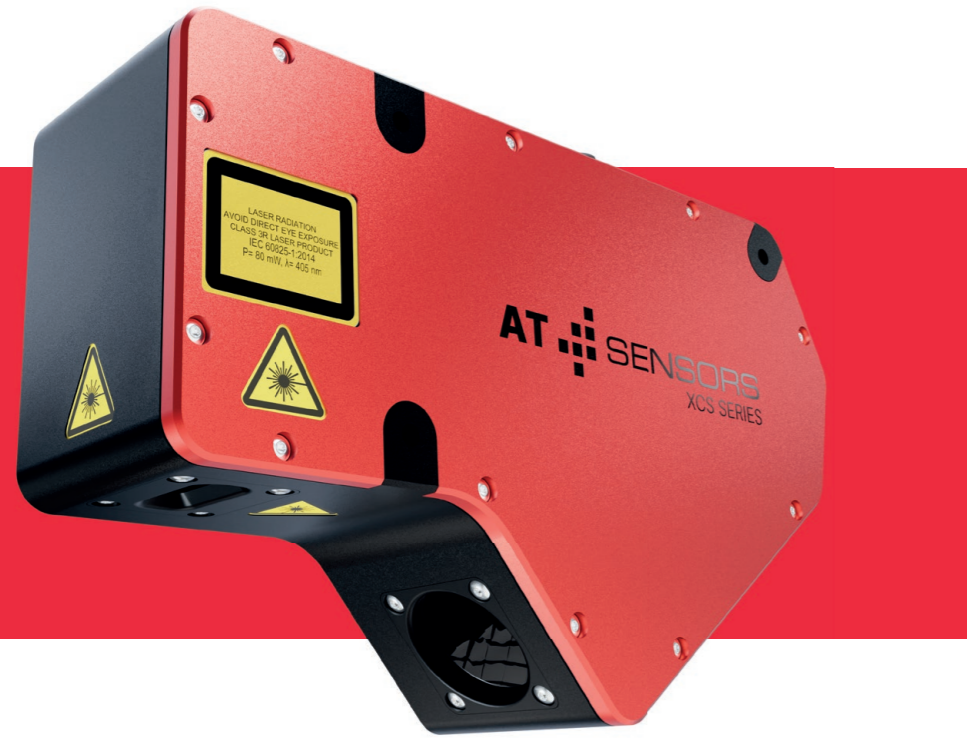


Technical Drawings Single-Head



XCS SERIES

with 5 Gigabit/s



Available Models:

3070 WARP:

- ✓ C7-S8-3070W-XCS-50-24-85-SX-5G-405-3R
- ✓ C7-S8-3070W-XCS-28-48-146-SX-5G-405-3R
- ✓ C7-S8-3070W-XCS-28-48-146-DX-5G-405-3R

3070:

- ✓ C7-S8-3070-XCS-50-24-85-SX-5G-405-3R
- ✓ C7-S8-3070-XCS-28-48-146-SX-5G-405-3R
- ✓ C7-S8-3070-XCS-28-48-146-DX-5G-405-3R

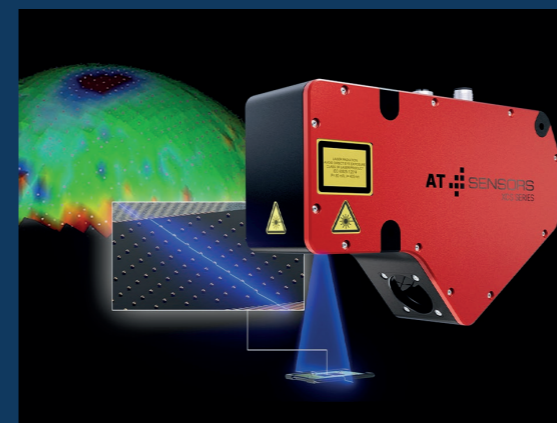
Benefits:

- Fills the gap in high-resolution (lateral X-resolution) sensors that we were previously unable to serve
- High-precision, ultra-thin laser line, 405 nm, 3R
- Developed for highly demanding inline inspection applications with high data transfer requirements



Good to know:

- ✓ Our first compact sensor with 5 GBit/s Interface
- ✓ Available with 3070 and 3070 WARP
- ✓ Newly designed housing
- ✓ Simultaneous data transfer of multiple features



Recommended Applications:

- ✓ Advanced Packaging
- ✓ Semiconductor
- ✓ Electronics

General Specifications for all XCS Models with 5G

Interface	Ethernet 100 Mb, 1 Gb, 2.5 Gb, 5 Gb
Inputs	Encoder A+, A -, B+, B -, Z+, Z- (HTL/TTL Level supported) Two freely configurable digital inputs (+5 to +24 VDC)
Outputs	Two freely configurable digital outputs (+5 to +24 VDC)
Power Supply	Sensor supply +10 to +24 VDC (max. +27 VDC) Laser supply +10 to +24 VDC
Housing	Anodized aluminum, IP67
Environmental Conditions	Operating temperature 0 °C to +40 °C Storage temperature -20 °C to +80 °C Humidity 20% to 80%
Vibration/Shock	Vibration resistance (sinusoidal): DIN EN 60068-2-6: 2008-10: 2g, 10-150 Hz Vibration resistance (random): DIN EN 60068-2-64: 2020-09: 7g, 10-500 Hz Shock resistance: DIN EN 60068-2-27: 2010-02: 15g, 3ms
Communication Protocols	GenICam, GigE Vision
Features	Automatic RegionTracking, Automatic RegionSearch, Multiple Regions, MultiPart, AutoStart, History Buffer, Multi-Slope, MultiPeak

Laser Specifications

Laser Wavelength	405 nm
Laser Class	3R

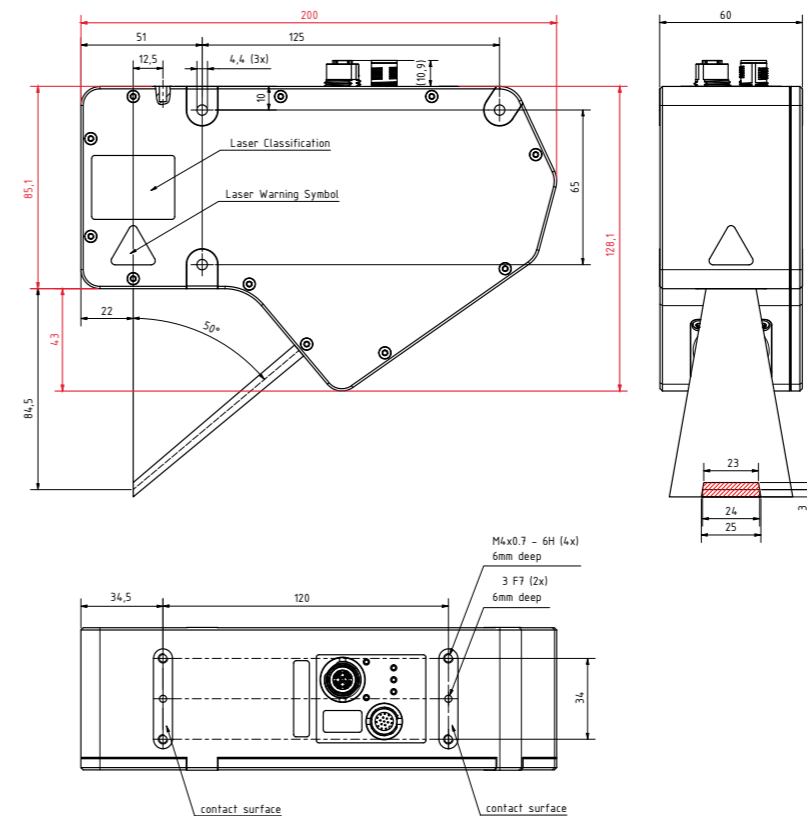
Models 3070 / 3070 WARP

Part Number / Model Name	602345872 / C7-S8-3070-XCS-50-24-85-SX-5G-405-3R 602346067 / C7-S8-3070W-XCS-50-24-85-SX-5G-405-3R 602346173 / C7-S8-3070W-XCS-28-48-146-SX-5G-405-3R 602346174 / C7-S8-3070W-XCS-28-48-146-DX-5G-405-3R 602346199 / C7-S8-3070-XCS-28-48-146-SX-5G-405-3R 602346200 / C7-S8-3070-XCS-28-48-146-DX-5G-405-3R
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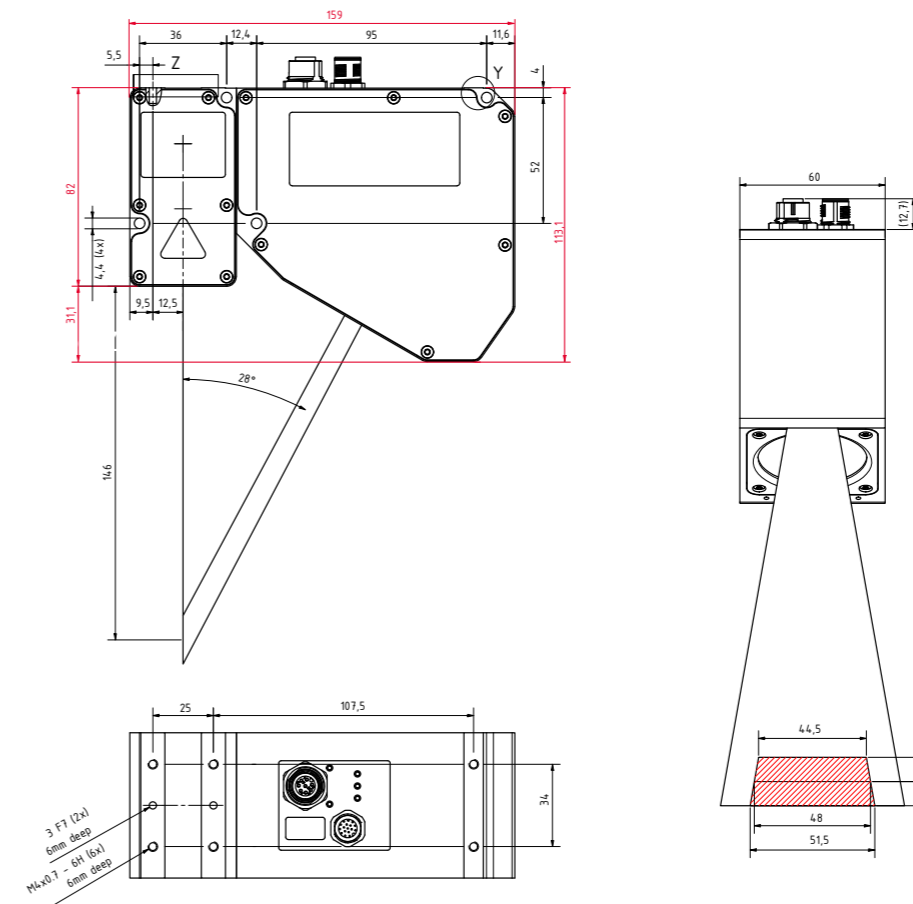
Optical Setup 3070 / 3070 WARP

Model	X-FOV 24 mm	X-FOV 48 mm
Lateral Resolution X	7.8 µm	15.6 µm
Height Resolution Z	0.13 µm (with 6 subpixels)	0.53 µm
Working Distance	84.5 mm	146 mm
X-FOV	24 mm	48 mm
Profile Resolution	3072 pixel per profile	3072 pixel per profile
Profile Speed	max. 94 kHz	max. 94 kHz
Z-Range Near to Far	6 mm	20 mm

Technical Drawings Model with X-FOV 24 mm



Technical Drawings Model with X-FOV 48 mm



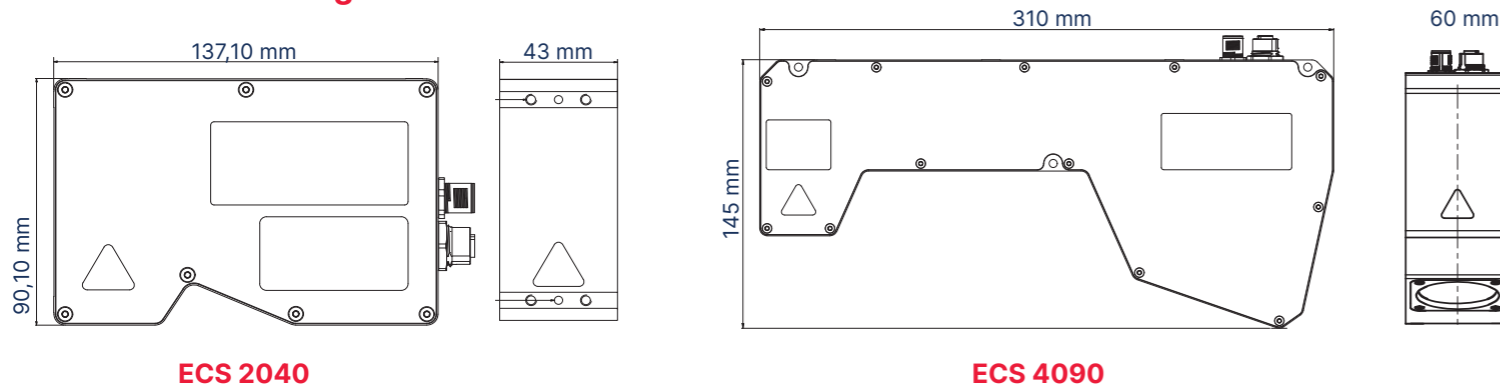
ECS SERIES



ECS 2040

ECS 4090

Technical Drawings



ECS 2040

ECS 4090

Technical Data

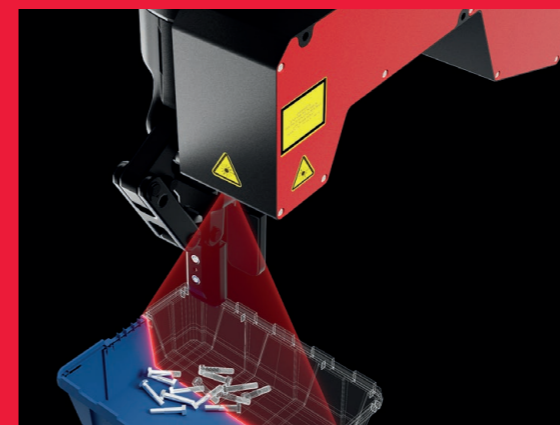
Laser Wavelength	660 nm
Laser Safety Class IEC	2M
Interface	Gigabit-Ethernet
Inputs	<ul style="list-style-type: none"> Encoder A+, A -, B+, B -, Z+, Z- (TTL Level) Two freely configurable digital inputs (+5 to +24 VDC)
Outputs	Two freely configurable digital outputs (+5 to +24 VDC)
Power Supply	<ul style="list-style-type: none"> Sensor supply +10 to +24 VDC (max. +27 VDC) Laser supply +10 to +24 VDC
Housing	Anodized aluminum , IP54
Environmental Conditions	<ul style="list-style-type: none"> Operating temperature 0 ° C to +40 ° C Storage temperature 20 ° C to +80 ° C Humidity 20 % to 80 %
Vibration/Shock	<ul style="list-style-type: none"> Vibration resistance (sinusoidal): DIN EN 60068-2-6: 2008-10: 2 g, 10-150 Hz Vibration resistance (random): DIN EN 60068-2-64: 2020-09: 7 g, 10-500 Hz Shock resistance: DIN EN 60068-2 27: 2010 02: 15 g, 3 ms
Standards	GenICam, GigE Vision
Features	Automatic Region-Tracking, Automatic Region-Search, Multiple Regions, Multi-Part, AutoStart, History Buffer, Multi-Slope, MultiPeak

Models

Model Name	Points	Working Distance (mm)	X-FOV (mm)	Z-Range (mm)	Resolution X Nominal (µm)	Resolution Z (µm)	Profile Speed at 200 rows	Max. Profile Speed
C6-S7-2040-ECS-23-100-106-SX-1G-660-2M	2048	106	102	60	49	1.9	1.8 kHz	25 kHz
C6-S7-2040-ECS-14-160-197-SX-1G-660-2M	2048	197	162	120	78	4.9	1.8 kHz	25 kHz
C6-S7-4090-ECS-30-288-400-SX-1G-660-2M	4096	400	284	250	71	2.1	2 kHz	24 kHz
C6-S7-4090-ECS-18-575-740-SX-1G-660-2M	4096	744	576	500	140	7.0	2 kHz	24 kHz
C6-S7-4090-ECS-18-1020-740-SX-1G-660-2M	4096	744	1020	900	249	12.5	2 kHz	24 kHz

Good to know:

- ✓ Price-performance ratio: Cost-effective laser profile sensor for demanding applications
- ✓ Software standards for easy integration: GigE Vision, GenICam, and third-party software support
- ✓ Cross-industry application: Ideal for the food industry, logistics, and robot vision



Recommended Applications:

- ✓ Food & Beverage
- ✓ Logistics & Packaging
- ✓ Robot Vision

C6 CA CAMERA

Designed for flexible laser triangulation set-ups with user-defined lasers and lenses.

Available Models:

- ✓ C6-S7-1280-CA-S0-M-1G: 1280 x 1024 pixels
- ✓ C6-S7-2040-CA-S0-M-1G: 2048 x 1088 pixels
- ✓ C6-S7-3070-CA-S0-M-1G: 3072 x 1020 pixels
- ✓ C6-S7-3070W-CA-S0-M-1G: 3072 x 1020 pixels with WARP
- ✓ C6-S7-4090-CA-S0-M-1G: 4096 x 3072 pixels

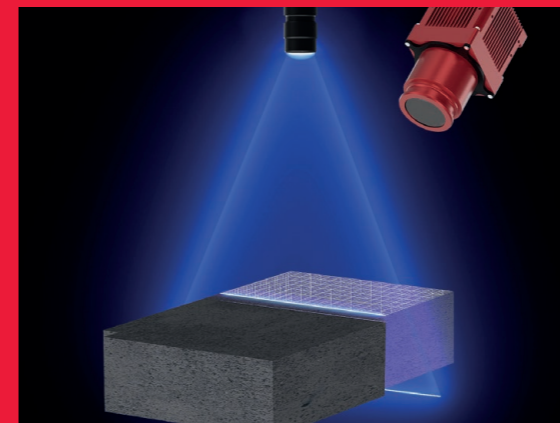
Standard Lens Mount Version with M42x1

Version with Optional C-Mount Adapter



Good to know:

- ✓ Designed for flexible laser triangulation set-ups with user-defined lasers and lenses
- ✓ Four different sensor resolutions available (1280, 2040, 3070, 4090)
- ✓ High industrial protection class IP67
- ✓ Available with various lens mounts and Scheimpflug adapters
- ✓ Lens protection tubes



Recommended Applications:

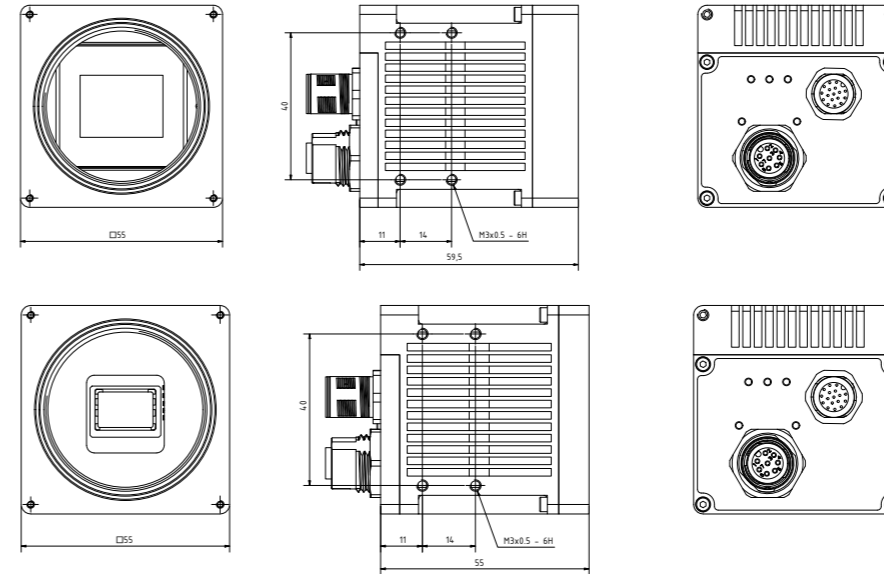
- ✓ Electronics & Semicon
- ✓ eMobility & Battery
- ✓ Automotive
- ✓ Metrology
- ✓ Industrial Automation
- ✓ Transportation
- ✓ Iron & Steel
- ✓ Pharmaceuticals
- ✓ Sorting & Recycling

Model Name	C6-1280-GigE			C6-2040-GigE		C6-3070-GigE / C6-3070-WARP-GigE			C6-4090-GigE	
Sensor Resolution	1280 × 1024			2048 × 1088		3072 × 1020			4096 × 3072	
Pixel Size	6.6 μm x 6.6 μm			5.5 μm x 5.5 μm		6.6 μm x 6.6 μm			5.5 μm x 5.5 μm	
Dynamic Range (*with HDR-3D)	90 dB			90 dB		90 dB			90 dB	
Digitization	10 Bit			10 Bit		10 bit			10 Bit	
Sensitivity	9.6 V/lux.s @ 525 nm			5.56 V/lux.s @ 550 nm		8 V/lux.s @ 525 nm			4.64 V/lux.s @ 550 nm	
Sensor Algorithm	MAX, TRSH, COG, FIR-PEAK			MAX, TRSH, COG, FIR-PEAK		MAX, TRSH, COG, FIR PEAK			MAX, TRSH, COG, FIR-PEAK	
Profile Length in 3D Mode	1280 Pixels per Profile			2048 Pixels per Profile		3072 Pixels per Profile			4096 Pixels per Profile	
Typical Profile Speed Depending on Number of Sensor Rows	Sensor Rows	Profile Speed in kHz		Sensor Rows	Profile Speed in kHz (with 2048 Pixels)	Profile Speed in kHz (with 3072 Pixels)		Sensor Rows	Profile Speed in kHz (with 4096 Pixels)	
		(with 1280 Pixels)	(with 688 Pixels)			C6-3070-GigE	C6-3070-WARP-GigE			
Height resolution can be increased by using TRSH (1/2 Pixel) or COG/FIR-PEAK (1/64 Pixel) without loss of speed	1024	1.1	1.9	1024	0.3	1020	1.0	9.2	3072	0.2
	256	4.3	7.7	256	1.4	384	2.6	22.9	512	0.9
	128	8.5	15.1	128	2.6	192	5.1	42.1	128	3.1
	32	32.8	54.2	32	9.7	48	17.8	88.9*	32	9.7
	16	63.0	95.7	16	16.0	12	47.9*	88.9*	16	14.9
8	116.0*	155.2	8	25.0	6	66.5*	88.9*	8	20.3	

*limited due to the 1 Gbit/s interface, faster profile rates are possible with upcoming NBASE-T interface

General C6 Camera Specifications	
Interface Specifications	
Digital Input	2 Electrical Isolated Inputs (5-24 V DC)
Digital Outputs	2 Electrical Isolated Outputs (5-24 V DC)
Encoder / Resolver Input	High-Speed Resolver Interface with Signals A, /A, B, /B, Z, /Z
Analog Output	Range: 0-5 V DC
Data Interface	GigE Vision with GenICam Protocol
Power Requirements	
Power Supply	10 - 24V DC
Power Consumption	max. 12 W
Mechanical Specifications	
Lens Mount	M42×1 / optional with C-Mount or F-Mount Adapter
Size	55 mm x 55 mm x 55 mm (2.16 × 2.16 × 2.16 in)
Mass (without Lens & Adaptor)	200 g
Housing Mount	M3 + Adaptor Plate with Metric and Inch Threads
Environmental Specifications	
Operating Temperature	0°C to +40°C (+32 to +104 °F) (Non-Condensing)
Storage Temperature	-20°C to +80°C (-4 to +176 °F)
General	
PC Requirements	Gigabit Ethernet NIC
Operating Systems	Windows 10 /11, Linux

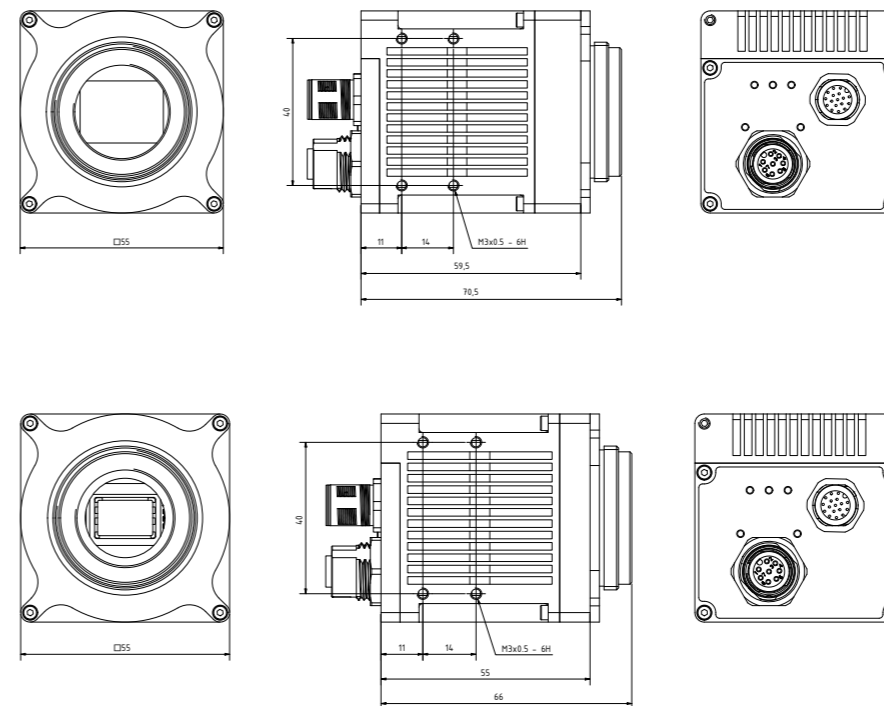
With Default Lens Mount M42×1



C6-4090-GigE

**C6-1280-GigE
C6-2040-GigE
C6-3070-GigE
C6-3070-WARP-GigE**

With C-Mount Adapter



C6-4090-GigE

**C6-1280-GigE
C6-2040-GigE
C6-3070-GigE
C6-3070-WARP-GigE**

C7 CA CAMERA

Designed for flexible laser triangulation set-ups with user-defined lasers and lenses.

Available Models:

- ✓ C7-S8-3070-CA-S0*-T-5G: 3072 x 1020 pixels
- ✓ C7-S8-3070W-CA-S0*-T-5GT: 3072 x 1020 pixels with WARP

* All models available with integrated Scheimpflug 0°, 5°, 8.5°, 10°



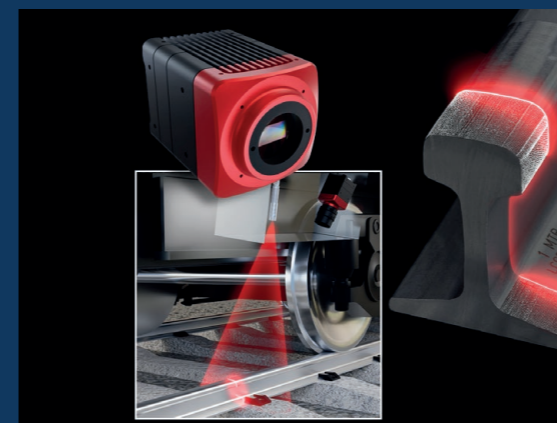
New connector layout for direct laser connection



With different tubus options

Good to know:

- ✓ Designed for flexible laser triangulation set-ups with user-defined lasers and lenses
- ✓ 5 times higher data throughput thanks to 5 Gigabit/s
- ✓ New laser interface for connecting common laser line projectors
- ✓ Available with TFL and C-mount and integrated Scheimpflug arrangement
- ✓ Lens protection tubes
- ✓ Simultaneous output of multiple different features



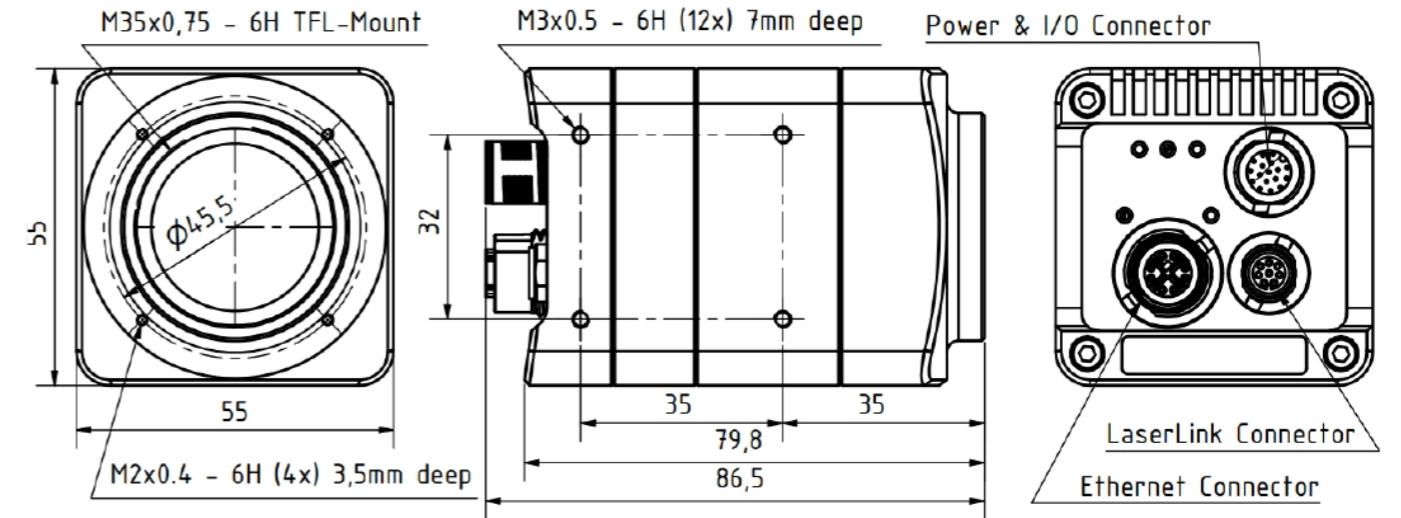
Recommended Applications:

- ✓ Advanced Packaging
- ✓ Road Scanning
- ✓ Railway Inspection

Model Name	C7-3070 / C7-3070W		
Sensor Resolution	3072 × 1020		
Pixel Size	6.6 μm x 6.6 μm		
Dynamic Range (*with HDR-3D)	90 dB		
Digitization	10 Bit		
Sensor Algorithm	MAX, TRSH, COG, FIR-PEAK		
Profile Length in 3D Mode	3072 Pixels per Profile		
Typical Profile Speed Depending on Number of Sensor Rows	Sensor Rows	Profile Speed in kHz	Profile Speed in kHz (WARP4)
Height resolution can be increased by using TRSH (1/2 Pixel) or COG/FIR-PEAK (1/64 Pixel) without loss of speed	1021 768 384 192 96 48	0.9 1.3 2.6 5 9.7 17.8	9.1 12 22.9 42 72 94

Technical Drawings

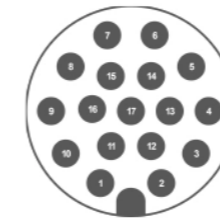
Mechanical dimensions



Connector layout and pin assignment

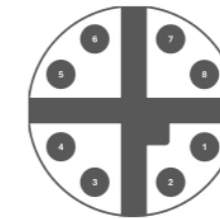
General C7 Camera Specifications	
Interface Specifications	
Digital Input	2 Electrical Isolated Inputs (5-24 V DC)
Digital Outputs	2 Electrical Isolated Outputs (5-24 V DC)
Encoder / Resolver Input	High-Speed Resolver Interface HTL/TTL/RS422 with Signals A, /A, B, /B, Z, /Z
Analog Output	Range: 0-5 V DC
Data Interface	GigE Vision with GenICam Protocol, 5GBase-T
Power Requirements	
Power Supply	10 - 24V DC
Power Consumption	max. 15 W
Mechanical Specifications	
Lens Mount	TFL-Mount, optional with C-Mount
Size	79,8 mm x 55 mm x 55 mm (3.14 × 2.16 × 2.16 in)
Mass (without Lens & Adaptor)	350 g
Housing Mount	M3 + Adaptor Plate with Metric and Inch Threads
Environmental Specifications	
Operating Temperature	0°C to +40°C (+32 to +104 °F) (Non-Condensing)
Storage Temperature	-20°C to +80°C (-4 to +176 °F)
General	
PC Requirements	Gigabit or 5G Ethernet Interface

Power & I/O Connector: M12 17-Pin A-Coded Male



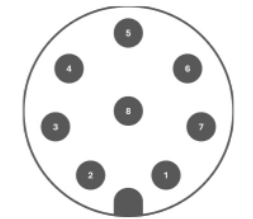
1	Z-	Encoder input Z- (RS-422, D-HTL)
2	L-VCC	Laser supply voltage (5-24V DC)
3	Z+	Encoder input Z+ (RS-422, TTL, D/SE-HTL)
4	B+	Encoder input B+ (RS-422, TTL, D/SE-HTL)
5	GND	Camera and Laser supply ground
6	B-	Encoder input B- (RS-422, D-HTL)
7	A-	Encoder input A- (RS-422, D-HTL)
8	VCC	Camera supply voltage
9	GND	Camera and Laser supply ground
10	A+	Encoder input A+ (RS-422, TTL, D/SE-HTL)
11	IN-GND	Reference ground for Encoder/Digital inputs
12	OUT2	Digital output 2, level defined by OUT-VCC
13	IN1	Digital input 1 (5-24V DC)
14	IN2	Digital input 2 (5-24V DC)
15	OUT-VCC	Output supply voltage (5-24V DC), refers to OUT-GND
16	OUT1	Digital output 1, level defined by OUT-VCC
17	OUT-GND	Reference ground for digital outputs
Shield	SHIELD	Connected to device housing

Ethernet Connector: M12 8-Pin X-Coded Female



1	MDI1+	Data Pair 1, positive contact
2	MDI1-	Data Pair 1, negative contact
3	MDI2+	Data Pair 2, positive contact
4	MDI2-	Data Pair 2, negative contact
5	MDI4+	Data Pair 4, positive contact
6	MDI4-	Data Pair 4, negative contact
7	MDI3+	Data Pair 3, positive contact
8	MDI3-	Data Pair 3, negative contact
Shield	SHIELD	Connected to device housing

LaserLink Connector: M8 8-Pin A-Coded Female



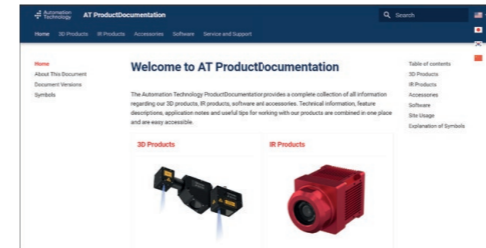
1	GND	Camera and Laser supply ground
2	VCC	Fused camera supply voltage output (5-24V DC)
3	L-VCC	Fused laser supply voltage output (5-24V DC)
4	AO	Analog output (0-5V)
5	DO	Digital output (5V)
6	TX	Transmit data output (RS-232)
7	RX	Receive data input (RS-232)
8	DI/AI	Digital/Analog input (0-5V)
Shield	SHIELD	Connected to device housing

INTEGRATE

AT SolutionPackage

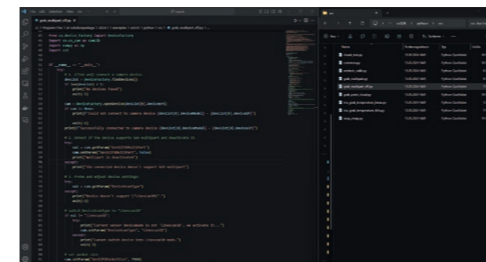
EASILY

The AT SolutionPackage consists of a variety of tools that can be used to acquire 3D images, configure the 3D camera and provide 3D data in the form of range maps or point clouds and more. This package is a software add-on to our 3D products.



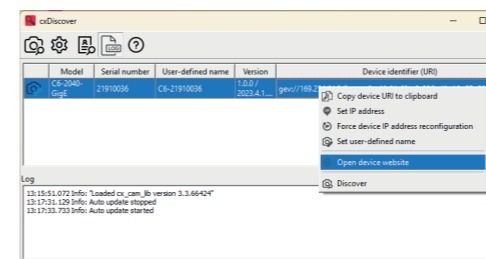
AT ProductDocumentation

- ✓ Complete documentation for all AT products including full support
- ✓ Easily accessible HTML documentation
- ✓ Offline version included



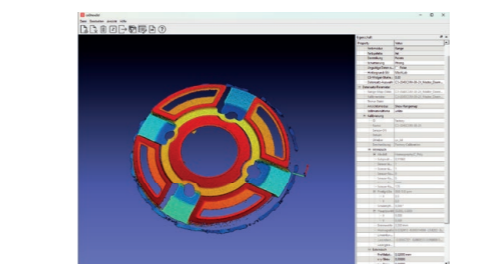
cxSDK

- ✓ SDK for image acquisition and camera configuration
- ✓ SDK for intrinsic and extrinsic calibration
- ✓ 3D point cloud and ZMap generation



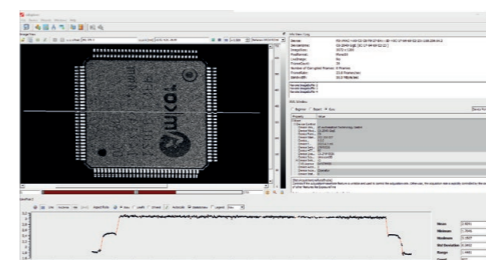
cxDiscover

- ✓ GigE Vision device discovery tool
- ✓ Network settings configuration



cxShow3D

- ✓ Sample tool with GUI for 3D point cloud visualization and ZMap generation

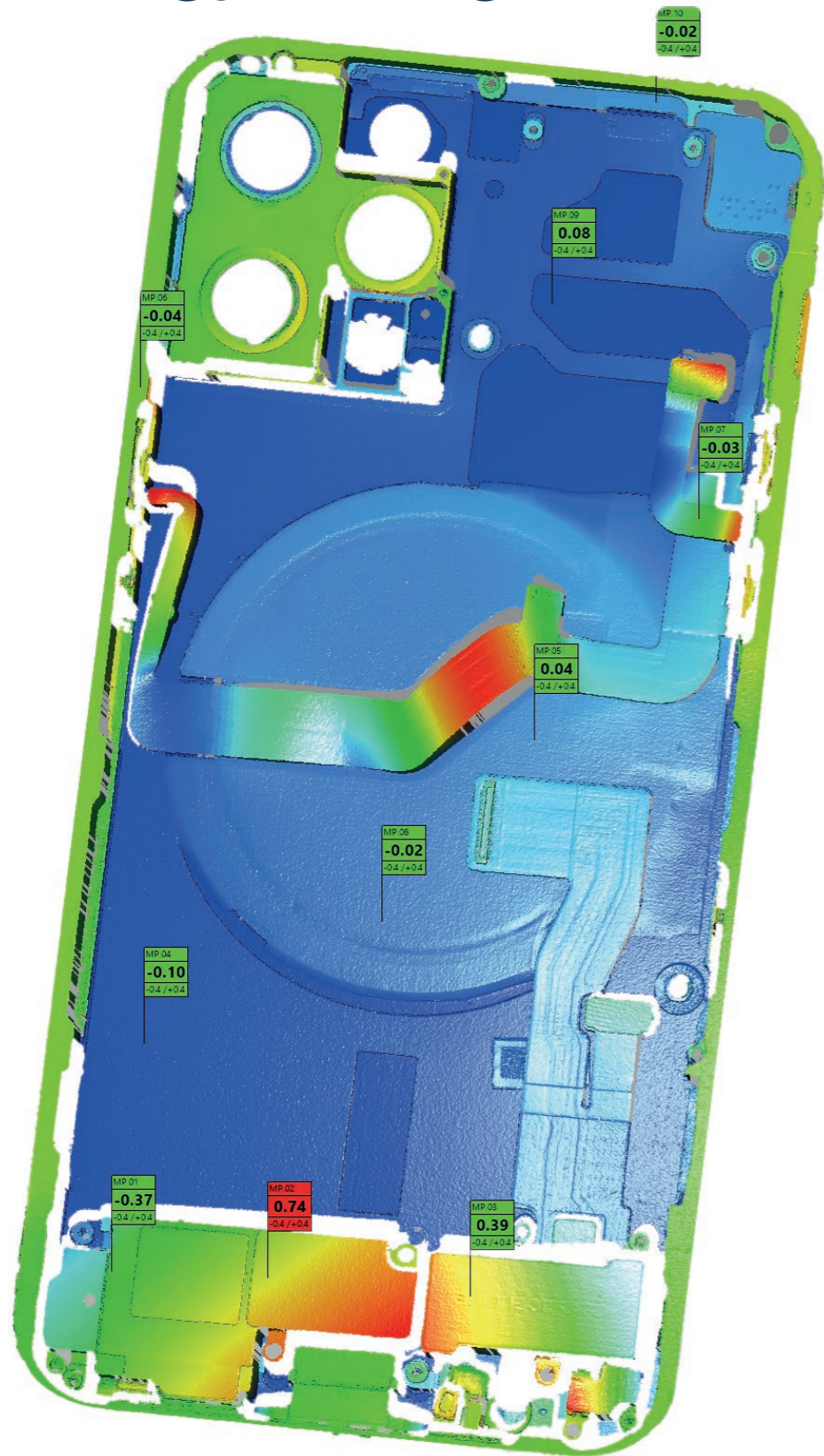


cxExplorer

- ✓ Software for 3D image acquisition, device configuration and data analysis

EVALUATE RAPIDLY

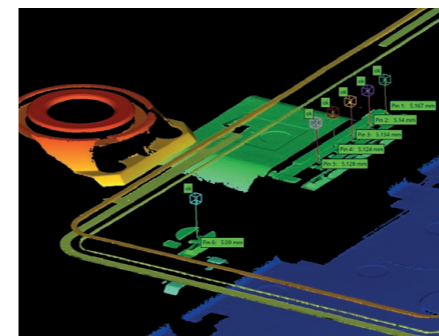
AT MetrologyPackage



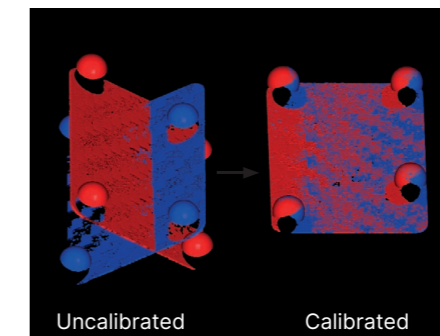
Our Smart 3D Software Add-on

- ✓ Easy to use software package for super-fast prototyping and deployment
- ✓ Simplified multi-sensor calibration
- ✓ Inline inspection per Reference Point System (RPS)
- ✓ Intelligent algorithms for 3D point cloud processing
- ✓ Includes GUI tool, source code and 3D sample data
- ✓ Basic version is free of charge
- ✓ Comprehensive developer version and runtime license available

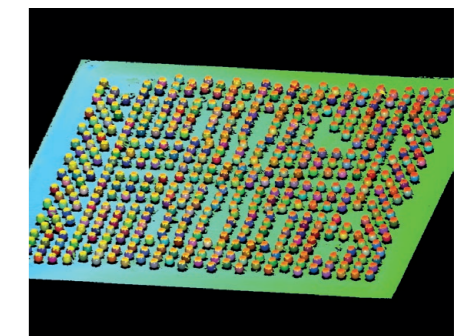
Metrology Application Examples



Pin Inspection



Multi-Scanner Calibration



BGA Inspection

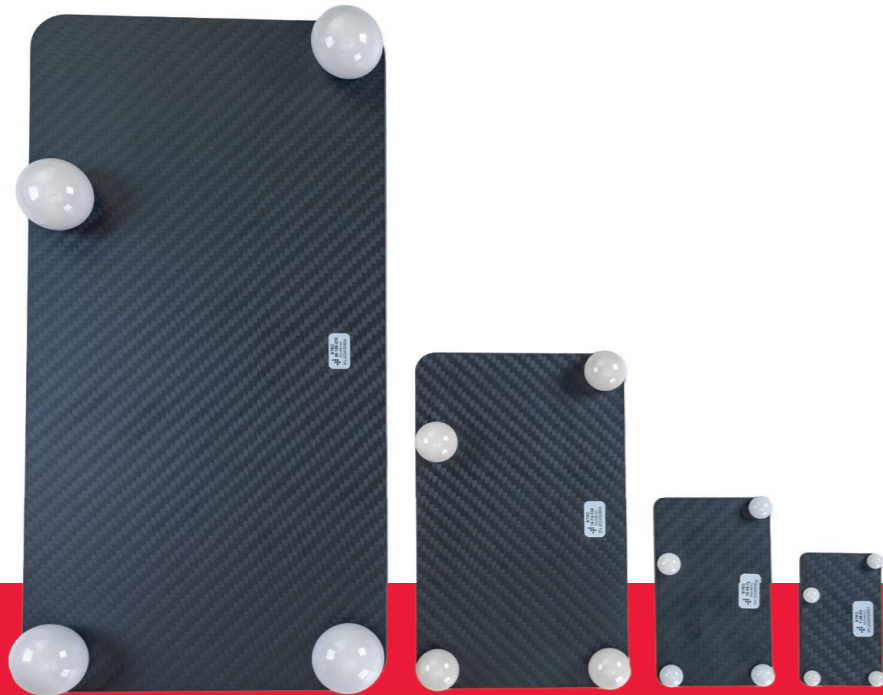
3D Measurements in Under 10 Minutes!

Fast + Easy
3D Software

- 1 **Install** AT SolutionPackage
- 2 **Scan** object
- 3 **Visualize** measurement data
- 4 **Design** evaluation

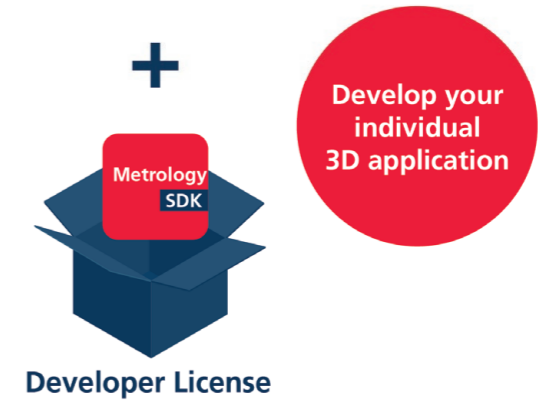
Improve your Multi-Scanner Calibration

- ✓ Four models depending on field of view
- ✓ Easy multi-scanner calibration
- ✓ Improved measurement quality
- ✓ Correction of linear transportation error



MetrologyPackage

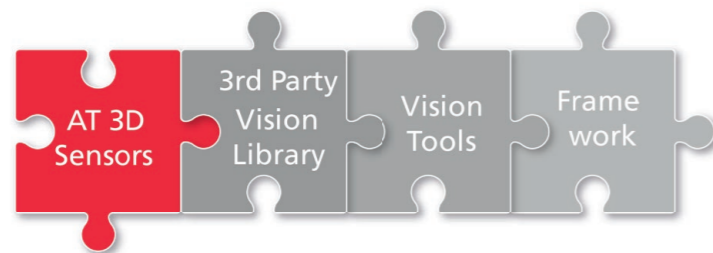
Create your 3D processing prototype within 10 minutes



Develop your Customer-Specific Application

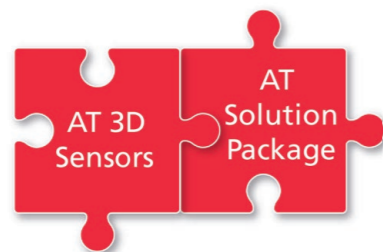
3D METROLOGY SOLUTION

PREVIOUS



Usual way to your individual solution

NOW



Easy way to your individual solution

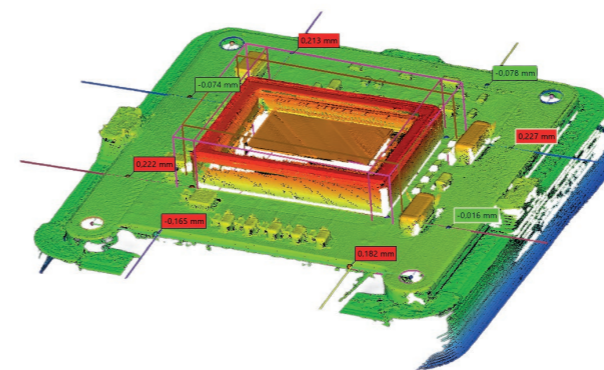


"The ultimate 3D Metrology Solution is like a 'puzzle' and we have all parts now!"

André Kasper, AT CTO



Developer License



Your Benefits Using the Developer License

- ✓ Build your own complete software solution
- ✓ Use this software solution for your own measurement tasks
- ✓ Integrate your measurement task into your application
- ✓ Optimized for metrology applications

Individual Design for Every Measurement Task



Learn more about our **Laser Profile Sensors:**
www.at-sensors.com



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Web: www.at-sensors.com